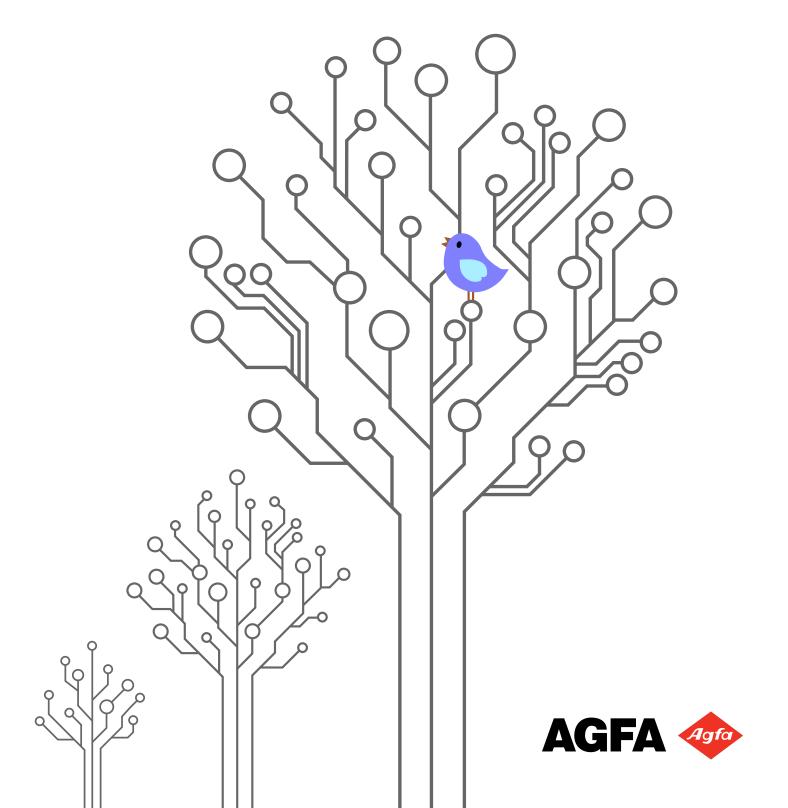
# CONDUCTIVE SILVER INKS FOR PRINTED ELECTRONICS



#### **FEATURES**

- High conductivity with low printed thickness
   50 mOhm/sq at 1-2 μm thick
- Low temperature sintering 130-150°C
- Fine-line printing down to 50 μm lines
- Inkjet support

#### BENEFITS

- Same performance as other silver inks but 3x lower silver consumption
- Transparent capacitive buttons by printing areas with invisible line patterns
- Digital manufacturing of PE devices becomes possible

#### **APPLICATIONS**

## CONDUCTIVE CIRCUITRY

- cap sensors for automotive, industrial and white goods
- antennas
- smart packaging



### TRANSPARENT ELECTRODES

- backlit cap touch elements
- ITO replacement

#### THE ORGACON PORTFOLIO

	SI-P2000	SI-J20x
Process	Screen printing	Inkjet printing
Substrate	treated/untreated PET ITO film / glass / FR-4 / PI	paper / cardboard treated PET
PROPERTY		
Resistivity (std. lab conditions)	<3 mOhm/sq/mil	<3 m0hm/sq/mil
Curing	10 min @ 130°C <2 sec with NIR	30 min @ 150°C <2 sec with NIR
Adhesion (ISO 2409)	0	0-1







Ink development and manufacturing processes are executed according to the Quality Management System of Agfa, which is ISO 9001 certified. Agfa is also ISO 14001 Environment certified.

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